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FAIRCHILD

SEMICONDUCTOR

November 2013

FQI4N90

N-Channel QFET® MOSFET

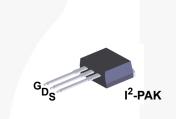
900 V, 4.2 A, 3.3 Ω

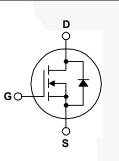
Description

This N-Channel enhancement mode power MOSFET is • 4.2 A, 900 V, $R_{DS(on)}$ = 3.3 Ω (Max.) @ V_{GS} = 10 V, produced using Fairchild Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state D = 2.1 A Low Gate Charge (Typ. 24 nC) resistance, and to provide superior switching performance • Low Crss (Typ. 9.5 pF) and high avalanche energy strength. These devices are suitable for switched mode power supplies, active power • 100% Avalanche Tested factor correction (PFC), and electronic lamp ballasts.

Features

- $I_{D} = 2.1 \text{ A}$





Absolute Maximum Ratings T_c = 25°C unless otherwise noted.

Symbol	Parameter		FQI4N90TU	Unit	
V _{DSS}	Drain-Source Voltage		900	V	
I _D	Drain Current - Continuous ($T_C = 25^{\circ}C$)		4.2	A	
	- Continuous (T _C = 100°C)		2.65	A	
I _{DM}	Drain Current - Pulsed	(Note 1)	16.8	A	
V _{GSS}	Gate-Source Voltage		± 30	V	
E _{AS}	Single Pulsed Avalanche Energy	(Note 2)	570	mJ	
I _{AR}	Avalanche Current	(Note 1)	4.2	A	
E _{AR}	Repetitive Avalanche Energy	(Note 1)	14	mJ	
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	4.0	V	
P _D	Power Dissipation $(T_A = 25^{\circ}C)^{*}$	3.13	W		
	Power Dissipation $(T_C = 25^{\circ}C)$		140	W	
	- Derate above 25°C	1.12	W/°C		
T _J , T _{stg}	Operating and Storage Temperature Range		-55 to +150	°C	
TL	Maximum lead temperature for soldering, 1/8" from case for 5 seconds.		300	°C	

Thermal Characteristics

Symbol	Parameter	FQI4N90TU	Unit
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	0.89	
$R_{ hetaJA}$	Thermal Resistance, Junction to Ambient (Minimum Pad of 2-oz Copper), Max.	62.5	°C/W
	Thermal Resistance, Junction to Ambient (*1 in ² Pad of 2-oz Copper), Max.	40	

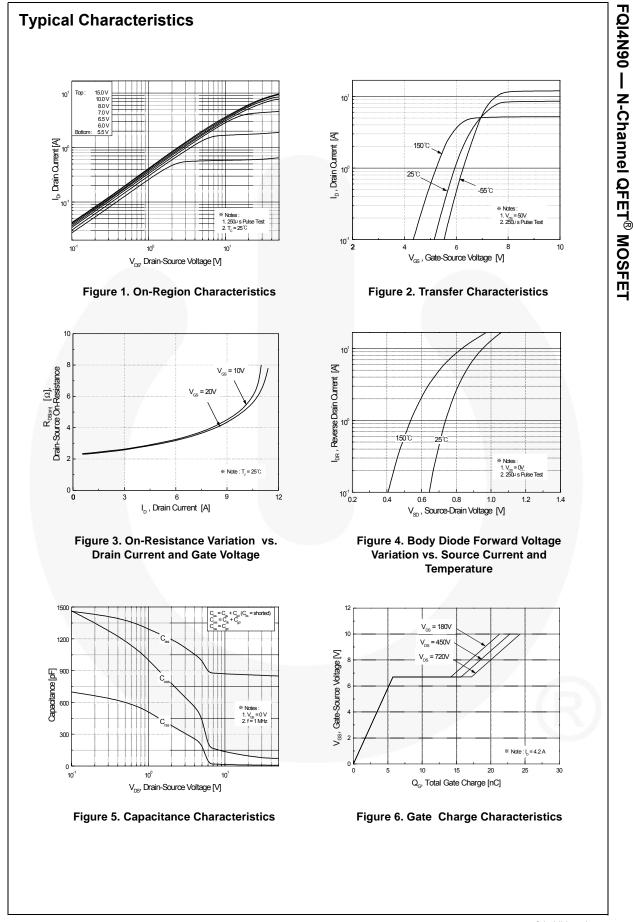
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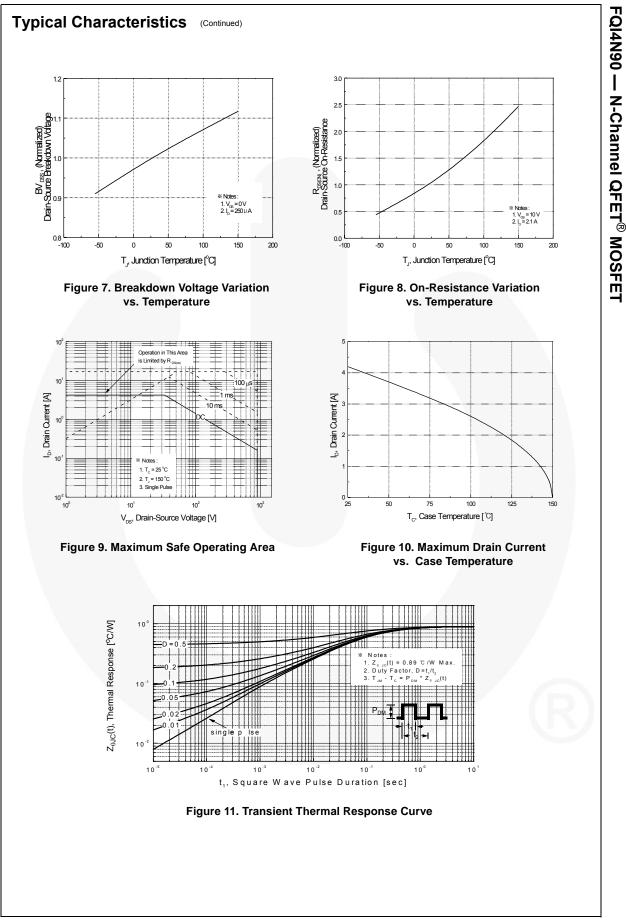
Part Number Top Mark FQI4N90TU FQI4N90		Top Mark	Pack	kage Packing Method	Reel	Size	Tape W	idth	Quantity	
		I ² -P	<u> </u>		N/.	A	N/A		50 units	
lectri	cal Cha	racteristics	To = 25°(Cunless of	nerwise noted.					
Symbol		Parameter			Test Conditions		Min.	Тур.	Max.	Unit
Off Cha	racteris	tics								
BV _{DSS}		irce Breakdown Vo	oltage	V _{GS} =	0 V, I _D = 250 μA		900			V
ΔBV _{DSS} /ΔTJ	Breakdow Coefficier	akdown Voltage Temperature		I _D = 25	50 μA, Referenced to	25°C		0.9		V/°C
DSS	5		rront		900 V, V _{GS} = 0 V				10	μA
			nem		720 V, T _C = 125°C				100	μA
GSSF	Gate-Bod	ate-Body Leakage Current, Forward		V _{GS} = 30 V, V _{DS} = 0 V					100	nA
GSSR	Gate-Bod	y Leakage Curren	t, Reverse	V _{GS} =	-30 V, V _{DS} = 0 V				-100	nA
On Cha	racterist	ics								
/ _{GS(th)}	Gate Thre	eshold Voltage		V _{DS} =	V _{GS} , I _D = 250 μA		3.0		5.0	V
R _{DS(on)}	Static Dra On-Resis	in-Source tance		V _{GS} =	10 V, I _D = 2.1 A			2.7	3.3	Ω
FS	Forward 7	Fransconductance	_	V _{DS} =	50 V, I _D = 2.1 A			3.5		S
Jvnami	ic Chara	cteristics								
Siss	Input Cap		_	V	$25 \sqrt{1} = 0 \sqrt{1}$			860	1100	pF
Coss		apacitance		20	V _{DS} = 25 V, V _{GS} = 0 V, ⁼ = 1.0 MHz			90	120	pF
Srss	Reverse ⁻	Fransfer Capacitar	ice					9.5	12.5	pF
Switchi	ng Char	acteristics		•						
d(on)		Delay Time	_					25	60	ns
r	Turn-On I	-	_		450 V, I _D = 4.2 A,			70	150	ns
d(off)	Turn-Off [Delay Time	-	R _G = 2	:5 12			45	100	ns
f	Turn-Off I	all Time		1		(Note 4)		40	90	ns
λ ^g	Total Gate	e Charge		Vne =	720 V, I _D = 4.2 A,			24	30	nC
λ _{gs}	Gate-Sou	rce Charge		V _{GS} =	_			5.8		nC
2 _{gd}	Gate-Dra	n Charge	0		(Note 4)		-	11.5		nC
								r		
Srain-S	I.				cimum Ratings	- /			4.2	A
SM		mum Continuous Drain-Source Di mum Pulsed Drain-Source Diode							16.8	A
/ _{SD}		Irce Diode Forward			0 V, I _S = 4.2 A				1.4	V
rr		Recovery Time			$0 \text{ V}, \text{ I}_{\text{S}} = 4.2 \text{ A},$			440		ns
יי 2 _m		Recovery Charge		00	t = 100 A/μs			3.3		μC
otes:	I									K
L = 61 mH, I _{SD} ≤ 4.2 A	$I_{AS} = 4.2 \text{ A}, V_D$, di/dt $\leq 200 \text{ A}/$	dth limited by maximum $_{D}$ = 50 V, R _G = 25 Ω, sta μs, V _{DD} ≤ BV _{DSS} , startir operating temperature.	rting $T_J = 25^{\circ}C$							

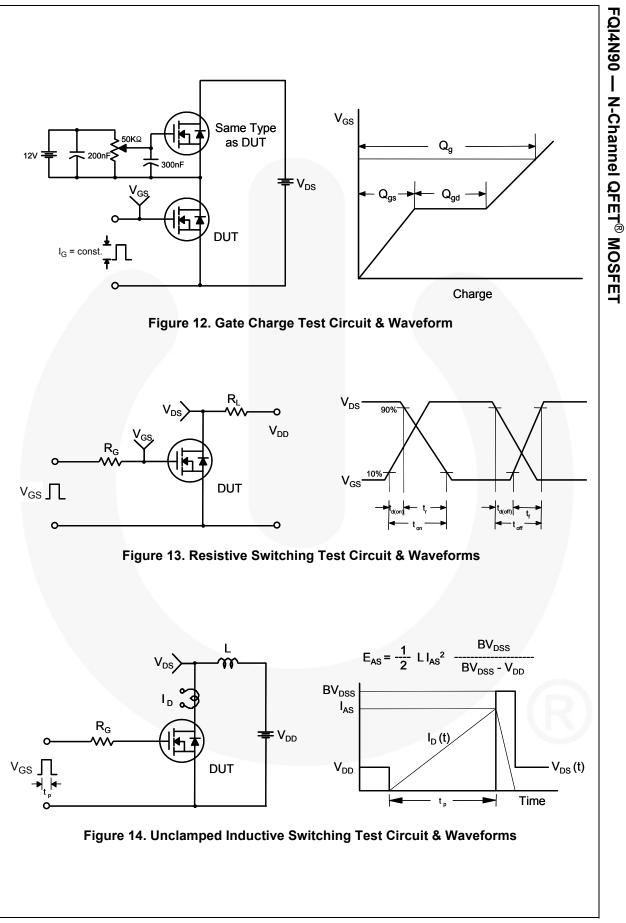
FQI4N90 — N-Channel QFET[®] MOSFET

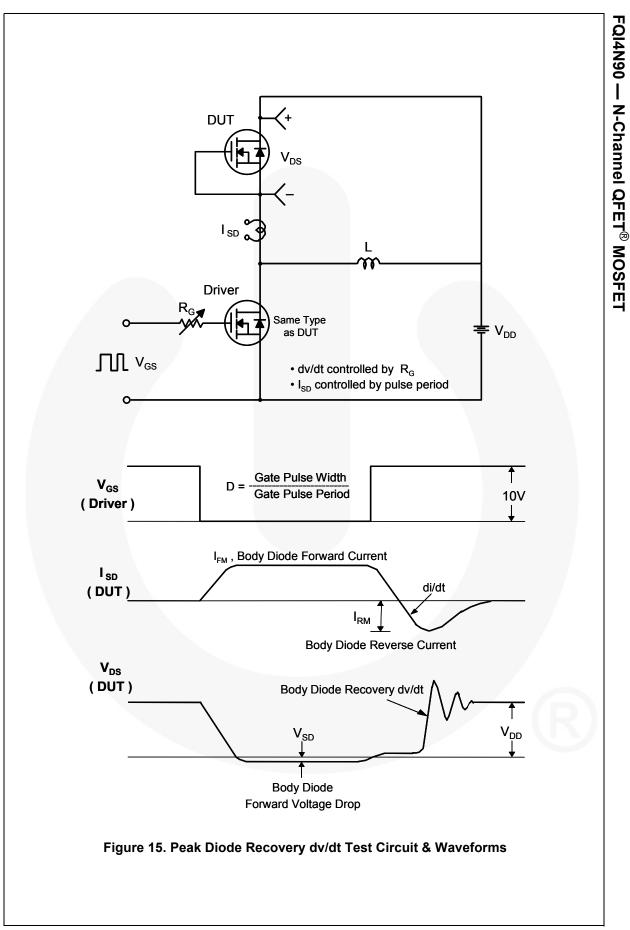
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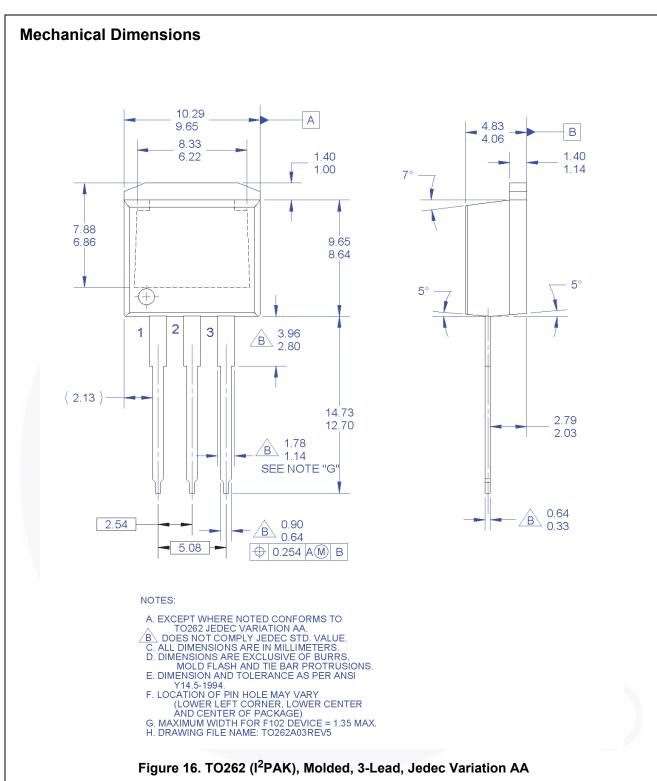


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FQ14N90 ---

N-Channel QFET[®] MOSFET



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		Rev. 166

QI4N90 —

N-Channel QFET[®] MOSFE

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